

PATENT ABSTRACTS OF JAPAN

(11)Publication number : 2002-226698

(43)Date of publication of application : 14.08.2002

(51)Int.Cl.

C08L 69/00

C08J 5/18

C08L 67/02

(21)Application number : 2001-027856

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(22)Date of filing : 05.02.2001

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FUKUMOTO WATARU**(54) RESIN COMPOSITION FOR PRINTING FILM SUPERIOR IN FOLD RESISTANCE AND DECORATING FILM THEREFROM**

(57)Abstract:

PROBLEM TO BE SOLVED: This invention provides a resin composition for printing films superior in fold resistance.**SOLUTION:** This resin composition for printing film, superior in fold resistance, comprising (A) 40-90 pts.wt. of an aromatic polycarbonate resin and (B) 10-60 pts.wt. of a polyester resin consisting of 0-100 wt.% of a polyethylene terephthalate resin and 0-90 wt.% of a polybutylene terephthalate resin, and the decorating film made therefrom are provided.